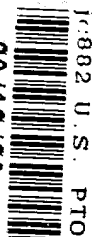


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A

In the United States Patent and Trademark Office

Mailed 2001, February 10th

Box Patent Application
 Assistant Commissioner for Patents
 Washington, District of Columbia 20231

Sir:

Please file the following enclosed patent application papers:

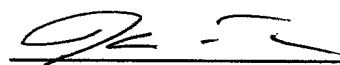
Applicant #1, Name: Haw-Minn Lu

Applicant #2, Name: _____

Title: Fanout Upgrade for a Scalable Switching Network

- ☒ Specification, Claims, and Abstract: Nr. of Sheets 26
- ☒ Declaration: Date Signed: February 10, 2002
- ☒ Drawings(s): Nr. of Sheets Enc.: Formal: 27 Informal: _____
- ☒ Small Entity Declaration of Inventor(s) ☐ SED of Non-Inventor / Assignee / Licensee
- ☐ Assignment enclosed with cover sheet and recordal fee; please record and return.
- ☒ Check for \$ 412 for:
- ☐ \$ _____ for filing fee (not more than three independent claims and twenty total claims are presented).
- ☐ \$ _____ additional if Assignment is enclosed for recordal.
- ☐ Disclosure Document Program reference letter.
- ☐ Pursuant to 35 U.S.C. §119(e)(i), applicant(s) claim priority of Provisional Patent Application Ser. Nr. _____, filed _____.
- ☒ Return Receipt Postcard Addressed to Applicant #1.
- ☐ Request Under MPEP § 707.07(j); The undersigned, a pro se applicant, respectfully request that if the Examiner finds patentable subject matter disclosed in this application, but feels that Applicant's present claims are not entirely suitable, the Examiner draft one or more allowable claims for applicant.

Very respectfully,


 Applicant #1 Signature

Applicant # 2 Signature _____

10733 Calston Way
 Address (Send Correspondence Here)
San Diego, CA 92126


Address _____

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: Date of Deposit 2001 February 10th

I hereby certify that this paper or fee is being deposited with the United States Postal Service using "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to "Box Patent Application, Assistant Commissioner for Patents, Washington, DC 20231."

Signed:


 Inventor

Patent Application Transmittal Letter

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